

Application Number Information

Application Number: **10/590210**

Assignments

Filing or 371(c) Date: **00/00/0000** eDan

Effective Date: **08/22/2006**

Application Received: **08/22/2006**

Patent Number:

Issue Date: **00/00/0000**

Date of Abandonment: **00/00/0000**

Attorney Docket Number: **59404US004**

Status: **19 /APPLICATION UNDERGOING PREEXAM PROCESSING** Status Date: **08/28/2006**

Confirmation Number: **4407**

Examiner Number: **00000 /**

Group Art Unit: **1732**
IFW Madras

Class/Subclass: **264/ .**

Lost Case: **NO**

Interference Number:

Unmatched Petition: **NO**

L&R Code: Secrecy Code:1

Third Level Review: **NO**

Secrecy Order: **NO**

Oral Hearing: **NO**

Title of Invention: **METHOD OF MOLDING FOR MICRONEEDLE ARRAYS**

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